

LTC5592 Dual 1.6GHz to 2.7GHz High Dynamic Range Downconverting Mixer

DESCRIPTION

Demonstration circuit 1710A-C is a dual 1.6GHz to 2.7GHz high dynamic range downconverting mixer featuring the LTC®5592. The LTC5592 is part of a family of dualchannel high dynamic range, high gain downconverting mixers covering the 600MHz to 4.5GHz frequency range. **The demo circuit 1710A-C and the LTC5592 are optimized for 1.6GHz to 2.7GHz RF applications. The LO frequency must fall within the 1.7GHz to 2.5GHz range for optimum performance.** A typical application is a LTE or WiMAX receiver with a 2.3GHz to 2.7GHz RF input and low side LO.

The LTC5592 is designed for 3.3V operation, however the IF amplifiers can be powered by 5V for the highest P1dB. A low current mode is provided for power savings, and each of the mixer channels has independent shutdown control.

The LTC5592's high conversion gain and high dynamic range enable the use of lossy IF filters in high-selective receiver designs, while minimizing the total solution cost, board space and system-level variation.

High Dynamic Range Dual Downconverting Mixer Family

DEMO #	IC PART #	RF RANGE	LO RANGE
DC1710A-A	LTC5590	600MHz to 1.7GHz	700MHz to 1.5GHz
DC1710A-B	LTC5591	1.3GHz to 2.3GHz	1.4GHz to 2.1GHz
DC1710A-C	LTC5592	1.6GHz to 2.7GHz	1.7GHz to 2.5GHz
DC1710A-D	LTC5593	2.3GHz to 4.5GHz	2.1GHz to 4.2GHz

Design files for this circuit board are available at http://www.linear.com/demo

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PERFORMANCE SUMMARY $T_C = 25^{\circ}C$, VCC = VCCIF = 3.3V, ENA = ENB = High, ISEL = Low, $P_{LO} = 0dBm$, $P_{RF} = -3dBm$ ($\Delta f = 2MHz$ for two-tone IIP3 tests), unless otherwise noted. (Note 1)

PARAMETER	CONDITIONS	VALUE	UNITS
VCC Supply Voltage Range		3.1 to 3.5	V
VCCIF Supply Voltage Range		3.1 to 5.3	V
Total Supply Current (VCC + VCCIF), Normal Power Mode	Both Mixer Channels Enabled	401	mA
Total Supply Current (VCC + VCCIF), Low Power Mode	Both Mixer Channels Enabled, ISEL = High	252	mA
Total Supply Current During Shutdown	ENA = ENB = Low	≤500	μA
ENA, ENB Input High Voltage (Channel Enabled)		>2.5	V
ENA, ENB Input Low Voltage (Channel Disabled)		<0.3	V
ENA, ENB Input Current	-0.3V to VCC + 0.3V	-20 to 30	μA
ISEL Input High Voltage (Low Power Mode)		>2.5	V
ISEL Input Low Voltage (Normal Power Mode)		<0.3	V
ISEL Input Current	-0.3V to VCC + 0.3V	-20 to 30	μA



PERFORMANCE SUMMARY $T_C = 25^{\circ}C$, VCC = VCCIF = 3.3V, ENA = ENB = High, ISEL = Low, $P_{LO} = 0dBm$, $P_{RF} = -3dBm$ ($\Delta f = 2MHz$ for two-tone IIP3 tests), unless otherwise noted. (Note 1)

PARAMETER	CONDITIONS	VALUE	UNITS
LO Input Frequency Range		1700 to 2500	MHz
LO Input Return Loss	$Z_0 = 50\Omega$, $f_{L0} = 1700$ MHz to 2500MHz	>17	dB
LO Input Power Range	f _{LO} = 1700MHz to 2500MHz	-4 to 6	dBm
RF Input Frequency Range	Low Side LO High Side LO	1900 to 2700 1600 to 2300	MHz MHz
RF Input Return Loss	$Z_0 = 50\Omega$, $f_{RF} = 1600$ MHz to 2700MHz	>13	dB
IF Output Frequency	Can be re-matched for other frequencies	190	MHz
IF Output Return Loss	$Z_0 = 50\Omega$	>12	dB
LO to RF Leakage	f _{LO} = 1700MHz to 2500MHz	< -34	dBm
LO to IF Leakage	f _{LO} = 1700MHz to 2500MHz	< -37	dBm
RF to LO Isolation	f _{RF} = 1600MHz to 2700MHz	>57	dB
RF to IF Isolation	f _{RF} = 1600MHz to 2700MHz	>37	dB
Channel-to-Channel Isolation	f _{RF} = 1600MHz to 2700MHz	>47	dB
Low Side LO Downmixer Application: ISEL =	Low, RF = 1900MHz to 2700MHz, IF = 190MHz, $f_{LO} = f_{RF} - f_{IF}$		
Conversion Gain	RF = 1950MHz RF = 2350MHz RF = 2550MHz	9.5 8.3 8.1	dB dB dB
Input 3rd Order Intercept	RF = 1950MHz RF = 2350MHz RF = 2550MHz	26.3 27.3 26.3	dBm dBm dBm
SSB Noise Figure	RF = 1950MHz RF = 2350MHz RF = 2550MHz	9.4 9.8 9.9	dB dB dB
SSB Noise Figure Under Blocking	f_{RF} = 2400MHz, f_{LO} = 2210MHz, f_{BLOCK} = 2500MHz, P_{BLOCK} = 5dBm P_{BLOCK} = 10dBm	15.3 21.2	dB dB
$2RF - 2LO$ Output Spurious Product ($f_{RF} = f_{LO} + f_{IF}/2$)	f _{RF} = 2255MHz at –10dBm, f _{LO} = 2160MHz, f _{IF} = 190MHz	-68	dBc
$3RF - 3LO$ Output Spurious Product $(f_{RF} = f_{LO} + f_{IF}/3)$	$f_{RF} = 2223.33MHz \text{ at } -10dBm, f_{LO} = 2160MHz, f_{IF} = 190MHz$	-74	dBc
Input 1dB Compression	$f_{RF} = 2350MHz$, VCCIF = 3.3V $f_{RF} = 2350MHz$, VCCIF = 5V	11 14.6	dBm dBm
Low Power Mode, Low Side LO Downmixer	Application: ISEL = High, RF = 1900MHz to 2700MHz, IF = 190I	$VHz, f_{LO} = f_{RF} - f_{IF}$	
Conversion Gain	RF = 2350MHz	7.1	dB
Input 3rd Order Intercept	RF = 2350MHz	22.3	dBm
SSB Noise Figure	RF = 2350MHz	10.2	dB
Input 1dB Compression	$f_{RF} = 2350MHz$, VCCIF = 3.3V $f_{RF} = 2350MHz$, VCCIF = 5V	11.3 12.6	dBm dBm





PERFORMANCE SUMMARY $T_C = 25^{\circ}C$, VCC = VCCIF = 3.3V, ENA = ENB = High, ISEL = Low, $P_{LO} = 0dBm$,

 $P_{RF} = -3dBm (\Delta f = 2MHz \text{ for two-tone IIP3 tests}), unless otherwise noted. (Note 1)$

PARAMETER	CONDITIONS	VALUE	UNITS
High Side LO Downmixer Application: ISEL =	Low, RF = 1600MHz to 2300MHz, IF = 190MHz, $f_{LO} = f_{RF} + f_{IF}$		·
Conversion Gain	RF = 1750MHz	9.1	dB
	RF = 1950MHz	8.7	dB
	RF = 2150MHz	8.3	dB
Input 3rd Order Intercept	RF = 1750MHz	25.3	dBm
	RF = 1950MHz	25.4	dBm
	RF = 2150MHz	25.1	dBm
SSB Noise Figure	RF = 1750MHz	9.2	dB
	RF = 1950MHz	9.8	dB
	RF = 2150MHz	10.4	dB
SSB Noise Figure Under Blocking	f_{RF} = 1950MHz, f_{LO} = 2140MHz, f_{BLOCK} = 1850MHz, P_{BLOCK} = 5dBm	16.5	dB
	P_{BLOCK} = 10dBm	22.7	dB
2LO - 2RF Output Spurious Product ($f_{RF} = f_{LO} - f_{IF}/2$)	$f_{RF} = 2045MHz$ at -10dBm, $f_{LO} = 2140MHz$, $f_{IF} = 190MHz$	-68	dBc
3LO - 3RF Output Spurious Product ($f_{RF} = f_{LO} - f_{IF}/3$)	$f_{RF} = 2076.67MHz \text{ at } -10dBm, f_{LO} = 2140MHz, f_{IF} = 190MHz$	-75	dBc
Input 1dB Compression	f_{RF} = 1950MHz, VCCIF = 3.3V	10.6	dBm
	f_{RF} = 1950MHz, VCCIF = 5V	14	dBm

Note 1: Subject to change without notice. Refer to the latest LTC5592 data sheet for most-up-to-date specifications.

DETRILED DESCRIPTION

ABSOLUTE MAXIMUM RATINGS

NOTE. Stresses beyond Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Supply Voltage (VCC)4.0\	/
IF Supply Voltage (VCCIF)5.5\	/
Enable Voltage (ENA, ENB)0.3V to VCC + 0.3V	
Bias Adjust Voltage (IFBA, IFBB) 0.3V to VCC + 0.3V	/
Power Select Voltage (ISEL)0.3V to VCC + 0.3V	/
LO Input Power (1GHz to 3GHz)9dBm	l
RFA, RFB Input Power (1GHz to 3GHz)15dBm	l
Operating Temperature Range (T _C)40°C to 105°C)

SUPPLY VOLTAGE RAMPING

Fast ramping of the supply voltage can cause a current glitch in the internal ESD protection circuits. Depending on the supply inductance, this could result in a supply voltage transient that exceeds the maximum rating. A supply voltage ramp time of greater than 1ms is recommended.

Do not clip powered test leads directly onto the demonstration circuit's VCC and VCCIF turrets. Instead, make all necessary connections with power supplies turned off, then increase to operating voltage.

ENABLE FUNCTION

The LTC5592's two mixer channels can be independently enabled or disabled. When the Enable voltage (ENA or ENB) is logic high (>2.5V), the corresponding mixer channel is enabled. When the Enable voltage is logic low (<0.3V), the mixer channel is disabled. The voltages at the enable pins should never fall below -0.3V or exceed the power supply voltage by more than 0.3V. The Enable pins must be pulled high or low. If left floating, the on/off state of the IC will be indeterminate. A logic table for the Enable control (ENA, ENB) is shown in Table 1.

-		
ENA, ENB	MIXER CHANNEL STATE	
Low	Disabled	
High	Enabled	
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DETAILED DESCRIPTION

LOW POWER MODE

The LTC5592 features a low power mode, which allows the flexibility to choose a 37% total power saving when lower RF performance is acceptable. When the ISEL voltage is logic low (<0.3V), both mixer channels operate at nominal power and best performance. When the ISEL voltage is logic high (>2.5V), both mixer channels are in low power mode and operate with reduced performance. The ISEL voltage should never fall below –0.3V or exceed the power supply voltage by more than 0.3V. The ISEL pin must be pulled low or high. If left floating, the operating state of the IC will be indeterminate. A logic table for ISEL is shown in Table 2.

Table 2. ISEL Logic Table

ISEL	OPERATING MODE	
Low	Normal power, best performance	
High	Low power, reduced performance	

RF INPUTS

Demonstration circuit 1710A-C's RF inputs of channel A and channel B are identical. For the RF inputs to be matched, the appropriate LO signal must be applied. The RF inputs' impedance is dependent on LO frequency, but the demonstration circuit 1710A-C's RF inputs are well matched to 50Ω from 1.6GHz to 2.7GHz, with better than 13dB return loss, when a 1.7GHz to 2.5GHz LO signal is applied.

LO INPUT

The LTC5592's LO amplifier is optimized for the 1.7GHz to 2.5GHz LO frequency range. LO frequencies above and below this frequency range may be used with degraded performance. The LO input is always 50Ω -matched when V_{CC} is applied to the chip, even when one or both of the channels is disabled. The nominal LO input level is 0dBm. The LO input power range is between -4dBm and 6dBm.

IF OUTPUTS

Demonstration circuit 1710A-C features single-ended, 50Ω -matched IF outputs for 190MHz. The channel A and the channel B IF outputs are identical, and the impedance matching is realized with a bandpass topology using IF transformers as shown in Figure 1. Only channel A is shown for clarity and simplicity.

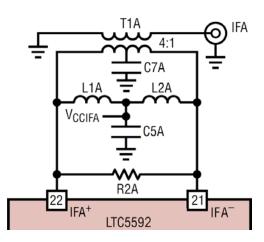


Figure 1. IF Output with Bandpass Matching

Demonstration circuit 1710A-C can be easily reconfigured for other IF frequencies by simply replacing inductors L1A, L2A, L1B and L2B. Inductor values for several common IF frequencies are presented in Table 3, and return losses are plotted in Figure 2. An external load resistor, R2A, can be used to improve impedance matching if desired.

Table 3. Inductor Values vs. IF Frequencies

IF FREQUENCY (MHz)	L1A, L2A, L1B, L2B (nH)
140	270
190	150
240	100
300	56
380	33
450	22

For IF frequencies below 90MHz, the values of the inductors become unreasonably high, and the lowpass topology shown in Figure 3 is preferred. See the LTC5592 data sheet for details.





DETAILED DESCRIPTION

Demonstration circuit 1710A-C's IF outputs can be easily converted to lowpass matching. Follow the procedures below, and refer to Figure 3 and Figure 4 to modify the channel A IF output. Modifications for Channel B are similar.

- a. Remove existing L1A, L2A, and C7A.
- b. Cut the traces leading to the IF transformer close to the pads of L1A and L2A.
- c. Insert series inductors onto the cut traces.
- d. Install a 0Ω jumper between the pads of C5A and C7A.
- e. Install resistor at location R2A.
- f. Install C9A next to, or on top of, R2A.

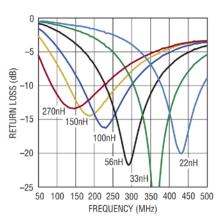


Figure 2. IF Output Return Loss with Bandpass Matching

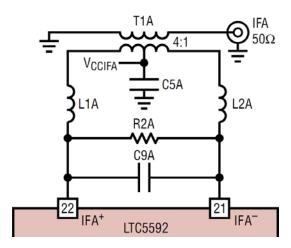


Figure 3. IF Output with Lowpass Matching

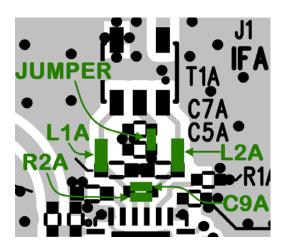


Figure 4. IF Output with Lowpass Matching

MEASUREMENT EQUIPMENT AND SETUP

The LTC5592 is a dual high dynamic range downconverting mixer IC with very high input 3rd order intercept. Accuracy of its performance measurement is highly dependent on equipment setup and measurement technique. The recommended measurement setups are presented in Figure 5, Figure 6, and Figure 7. The following precautions should be observed:

- 1. Use high performance signal generators with low harmonic output and low phase noise, such as the Rohde & Schwarz SME06. Filters at the signal generators' outputs may also be used to suppress higher-order harmonics.
- 2. A high quality RF power combiner that provide broadband 50Ω -termination on all ports and have good port-to-port isolation should be used, such as the MCLI PS2-17.
- 3. Use high performance amplifiers with high IP3 and high reverse isolation, such as the Mini-Circuits ZHL-1042J, on the outputs of the RF signal generators to improve source isolation to prevent the sources from modulating each other and generating intermodulation products.
- 4. Use attenuator pads with good VSWR on the demonstration circuit's input and output ports to improve

MEASUREMENT EQUIPMENT AND SETUP

source and load match to reduce reflections, which may degrade measurement accuracy.

- 5. A high dynamic range spectrum analyzer, such as the Rohde & Schwarz FSEM30, should be used for linearity measurement.
- 6. Use narrow resolution bandwidth (RBW) and engage video averaging on the spectrum analyzer to lower the displayed average noise level (DANL) in order to improve sensitivity and to increase dynamic range. However, the trade off is increased sweep time.
- 7. Spectrum analyzers can produce significant internal distortion products if they are overdriven. Generally, spectrum analyzers are designed to operate at their best with about –30dBm at their input filter or preselector. Sufficient spectrum analyzer input attenuation should be used to avoid saturating the instrument, but too much attenuation reduces sensitivity and dynamic range.
- 8. Before taking measurements, the system performance should be evaluated to ensure that:
 - a. Clean input signals can be produced. The two-tone signals' OIP3 should be at least 15dB better than the DUT's IIP3.

- b. The spectrum analyzer's internal distortion is minimized.
- c. The spectrum analyzer has enough dynamic range and sensitivity. The measurement system's IIP3 should be at least 15dB better than the DUT's OIP3.
- d. The system is accurately calibrated for power and frequency.

A SPECIAL NOTE ABOUT RF TERMINATION

The LTC5592 consists of high linearity passive doublebalanced mixer cores and IF buffer amplifiers. Due to the bidirectional nature of all passive mixers the LO±IF mixing products, also referred to as pseudo-image spurs, are always present at the RF input, typically at a level 12dB below the RF input signal. Mismatched impedances at the pseudo-image spur frequencies, such as when filters are used for SSB NF measurements, can significantly impact the linearty and noise figure measurements. To avoid interference from the pseudo-image spurs, terminate the RF input port with an isolator, diplexer, or attenuator. In the recommended measurement setups presented in Figure 6 and Figure 7, the 6dB attenuator pad at the demonstration circuit's RF input serves this purpose.

QUICK START PROCEDURE

Demonstration circuit 1710A-C is easy to set up to evaluate the performance of the LTC5592. Refer to Figure 5, Figure 6, and Figure 7 for proper equipment connections. The following procedures describe performing measurements on Mixer Channel A. The measurement procedures for Mixer Channel B are identical.

NOTE. Care should be taken to never exceed absolute maximum input ratings. Make all connections with RF and DC power off.

RETURN LOSS MEASUREMENTS

- 1. Configure the Network Analyzer for return loss measurement, set appropriate frequency range, and set the test signal to –3dBm.
- 2. Calibrate the Network Analyzer.
- 3. Connect all test equipment as shown in Figure 5 with the signal generator and the DC power supply turned off.
- 4. Increase the DC power supply voltage to 3.3V, and verify that the total current consumption is close to the figure listed in the Typical Demonstration Circuit Performance Summary. The supply voltage should be confirmed at the demo board VCC, VCCIF and GND terminals to account for lead ohmic losses.

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QUICK START PROCEDURE

- 5. With the LO signal applied, and all unused demo board ports terminated in 50Ω , measure return losses of the RFA input and IFA output ports.
- 6. Set the test signal to 0dBm, and re-calibrate the Network Analyzer.
- 7. Terminate all unused demo board ports in 50 Ω . Measure return losses of the LO input port.

RF PERFORMANCE MEASUREMENTS

- 1. Connect all test equipment as shown in Figure 6 with the signal generators and the DC power supply turned off.
- 2. Increase the DC power supply voltage to 3.3V, and verify that the total current consumption is close to the figure listed in the Typical Demonstration Circuit Performance Summary. The supply voltage should be confirmed at the demo board VCC, VCCIF and GND terminals to account for lead ohmic losses.
- 3. Set the LO source (Signal Generator 1) to provide a OdBm CW signal at appropriate LO frequency to the demo board LO input port.
- 4. Set the RF sources (Signal Generators 2 and 3) to provide two –3dBm CW signals, 2MHz apart, at the appropriate RF frequencies to the demo board RFA input port.
- 5. Measure the resulting IFA output on the Spectrum Analyzer:
 - a. The wanted two-tone IF output signals are at:

$$\begin{split} f_{IF1} &= f_{RF1} - f_{L0}, \text{ and } \\ f_{IF2} &= f_{RF2} - f_{L0} \text{ for low side LO}, \\ and \\ f_{IF1} &= f_{L0} - f_{RF1}, \text{ and } \\ f_{IF2} &= f_{L0} - f_{RF2} \text{ for high side LO} \end{split}$$

b. The 3rd order intermodulation products which are closest to the wanted IF signals are used to calculate the Input 3rd Order Intercept:

$$\begin{split} f_{IM3,1} &= f_{RF1} - f_{LO} - \Delta_{IF}, \text{ and} \\ f_{IM3,2} &= f_{RF2} - f_{LO} + \Delta_{IF} \text{ for low side LO}, \\ \text{and} \\ f_{IM3,1} &= f_{LO} - f_{RF1} + \Delta_{IF}, \text{ and} \\ f_{IM3,2} &= f_{LO} - f_{RF2} - \Delta_{IF} \text{ for high side LO} \\ \text{Where } \Delta_{IF} &= f_{RF2} - f_{RF1}. \end{split}$$

6. Calculate Input 3rd Order Intercept:

 $IIP3 = (\Delta_{IM3})/2 + P_{RF}$

Where $\Delta_{IM3} = P_{IF} - P_{IM3}$. P_{IF} is the lowest IF output signal power at either f_{IF1} or f_{IF2} . P_{IM3} is the highest 3rd order intermodulation product power at either $f_{IM3,1}$ or $f_{IM3,2}$. P_{RF} is the per tone RF input power.

7. Turn off one of the RF signal generators, and measure Conversion Gain, RF to IF isolation, LO to IF leakage, and Input 1dB compression point.

NOISE FIGURE MEASUREMENT

- 1. Configure and calibrate the noise figure meter for mixer measurements.
- 2. Connect all test equipment as shown in Figure 7 with the signal generator and the DC power supply turned off.
- 3. Increase the DC power supply voltage to 3.3V, and verify that the total current consumption is close to the figure listed in the Typical Demonstration Circuit Performance Summary. The supply voltage should be confirmed at the demo board VCC, VCCIF and GND terminals to account for lead ohmic losses.
- 4. Measure the single-sideband noise figure.



QUICK START PROCEDURE

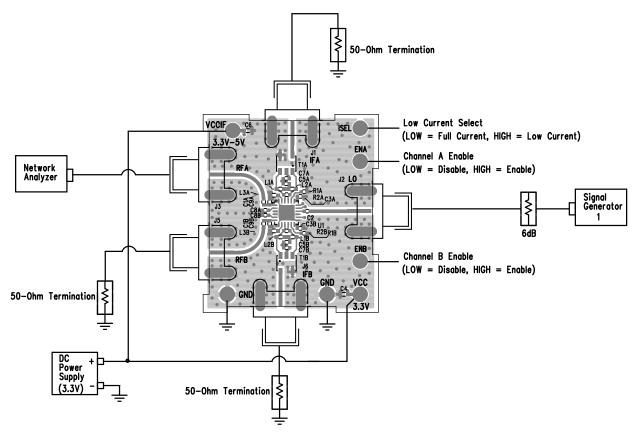


Figure 5. Proper Equipment Setup for Return Loss Measurements

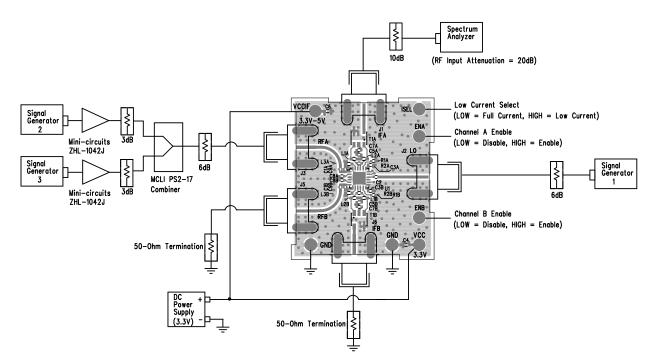


Figure 6. Proper Equipment Setup for RF Performance Measurements





QUICK START PROCEDURE

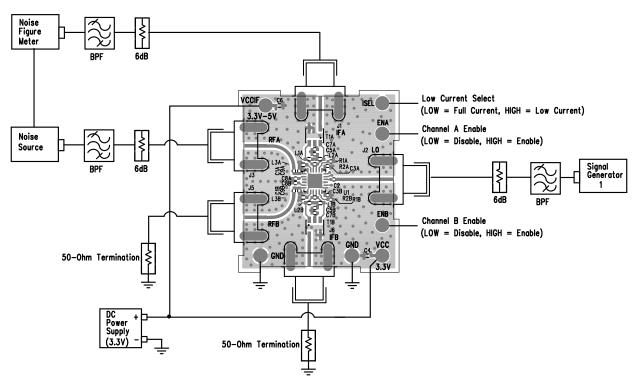


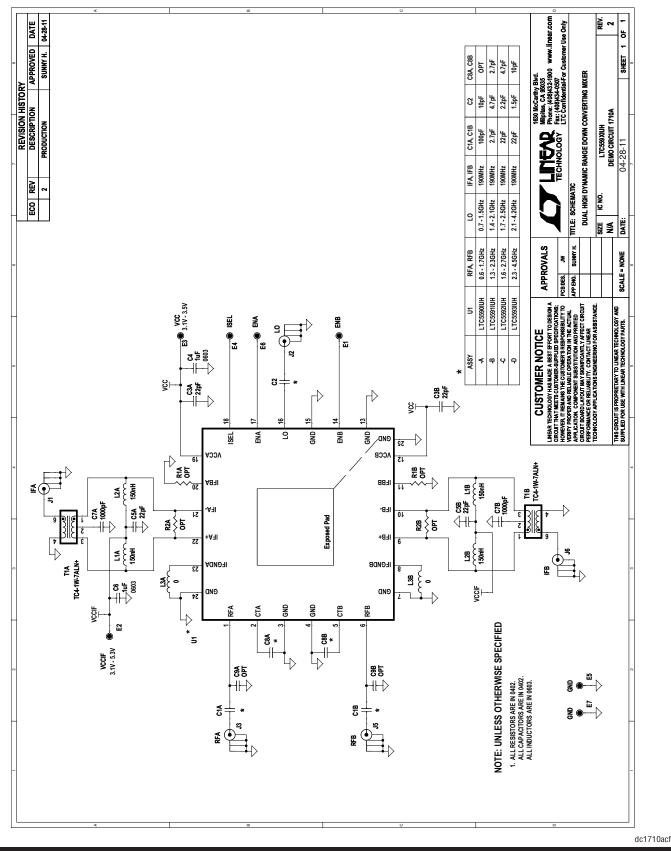
Figure 7. Proper Equipment Setup for Noise Figure Measurement

PARTS LIST

ITEM	QTY	REFERENCE	PART DESCRIPTION	MANUFACTURER/PART NUMBER
1	6	C1A, C1B, C3A, C3B, C5A, C5B	CAP., COG, 22pF, ±1%, 50V, 0402	AVX, 04025A220FAT
2	1	C2	CAP., COG, 2.2pF, ±0.1pF, 50V, 0402	AVX, 04025A2R2BAT
3	2	C4, C6	CAP., X5R, 1µF, ±10%, 10V, 0603	AVX, 0603ZD105KAT
4	2	C7A, C7B	CAP., X7R, 1000pF, ±5%, 50V, 0402	AVX, 04025C102JAT
5	2	C8A, C8B,	CAP., COG, 4.7pF, ±0.1pF, 50V, 0402	AVX, 04025A4R7BAT
6	0	C9A, C9B (OPT)	CAP., 0402, OPTION	
7	7	E1, E2, E3, E4, E5, E6, E7	TESTPOINT, TURRET, 0.061"	MILL-MAX, 2308-2-00-80-00-00-07-0
8	5	J1, J2, J3, J5, J6	CONN., SMA, 50 Ω , EDGE-LAUNCH	AMPHENOL CONNEX, 132357
9	4	L1A, L1B, L2A, L2B	IND., WIRE-WOUND, 150nH, ±2%, 0603	COILCRAFT, 0603CS-R15XGLW
10	2	L3A, L3B	RES., CHIP, 0Ω, 0603	VISHAY, CRCW06030000Z0EA
11	0	R1A, R1B, R2A, R2B (OPT)	RES., 0402, OPTION	
12	2	T1A, T1B	TRANSFORMER, SMT, RF WIDEBAND, 4:1	MINI-CIRCUITS, TC4-1W-7ALN+
13	1	U1	IC., LTC5592IUH, QFN 5X5	LINEAR TECHNOLOGY, LTC5592IUH#PBF



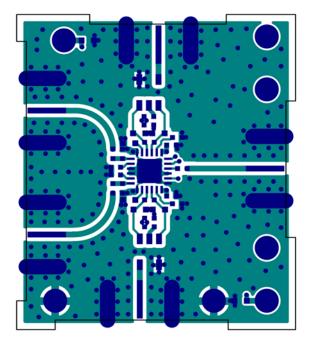
SCHEMATIC DIAGRAM





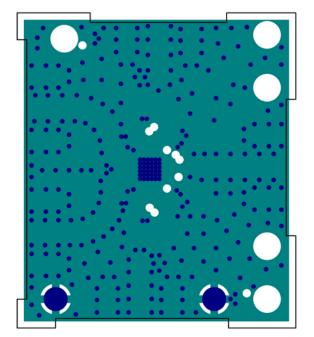
PCB LAYOUT

Layer 1. Top Layer

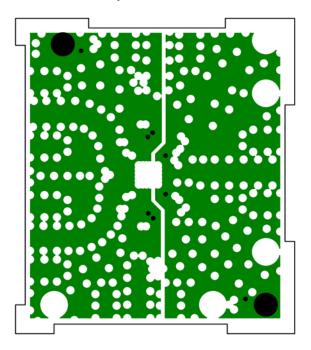


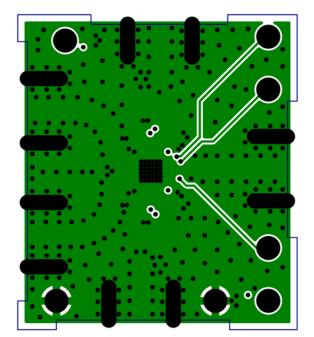
Layer 3. Power Plane





Layer 4. Bottom Layer







DEMO MANUAL DC1710A-C

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Mailing Address:

Linear Technology 1630 McCarthy Blvd. Milpitas, CA 95035

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Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;

- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);

- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;

- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком):

- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный) Факс: 8 (812) 320-03-32 Электронная почта: ocean@oceanchips.ru Web: http://oceanchips.ru/ Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А